

DMMT5551/DMMT5551S

MATCHED NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

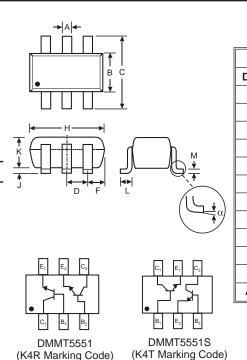
- **Epitaxial Planar Die Construction**
- Complementary PNP Type Available (DMMT5401)

Pb

- Ideal for Low Power Amplification and Switching
- Intrinsically Matched NPN Pair (Note 1)
- 2% Matched Tolerance, hFE, VCE(SAT), VBE(SAT)
- Lead Free/RoHS Compliant (Note 4)
- "Green" Device (Note 5 and 6)

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 7. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Marking (See Page 2): K4R & K4T
- Ordering & Date Code Information: See Page 2
- Weight: 0.006 grams (approximate)



	SOT-26										
Dim	Min	Мах	Тур								
Α	0.35	0.50	0.38								
В	1.50	1.70 1.60 3.00 2.80 0.95 0.55									
С	2.70	3.00	2.80								
D			0.95								
F			0.55								
Н	2.90	3.10	3.00								
J	0.013	0.55 3.10 3.00 3 0.10 0.05 1.30 1.10									
К	1.00	1.30	1.10								
L	0.35	0.55	0.40								
М	0.10	0.20	0.15								
	0°	8°									
All D	imens	ions ir	mm								

(K4T Marking Code)

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	180	V
Collector-Emitter Voltage	V _{CEO}	160	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current - Continuous (Note 2)	Ι _C	200	mA
Power Dissipation (Note 2, 3)	Pd	300	mW
Thermal Resistance, Junction to Ambient (Note 2)	R _{JA}	417	°C/W
Operating and Storage and Temperature Range	T _j , T _{STG}	-55 to +150	°C

Notes: 1. Built with adjacent die from a single wafer.

2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

- 3. Maximum combined dissipation.
- 4. No purposefully added lead.

5. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php..

6. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	-,				
Collector-Base Breakdown Voltage	V _{(BR)CBO}	180		V	$I_{\rm C} = 100 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	160		V	$I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	6.0		V	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$
Collector Cutoff Current	I _{CBO}		50	nA μA	$V_{CB} = 120V, I_E = 0$ $V_{CB} = 120V, I_E = 0, T_A = 100^{\circ}C$
Emitter Cutoff Current	I _{EBO}		50	nA	$V_{EB} = 4.0V, I_C = 0$
ON CHARACTERISTICS (Note 7)				•	•
DC Current Gain (Note 8)	h _{FE}	80 80 30	250		$ \begin{array}{c} I_{C} = 1.0 \text{mA}, \ V_{CE} = 5.0 \text{V} \\ I_{C} = 10 \text{mA}, \ V_{CE} = 5.0 \text{V} \\ I_{C} = 50 \text{mA}, \ V_{CE} = 5.0 \text{V} \end{array} $
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		0.15 0.20	V	$I_{C} = 10mA, I_{B} = 1.0mA$ $I_{C} = 50mA, I_{B} = 5.0mA$
Base-Emitter Saturation Voltage	V _{BE(SAT)}		1.0	V	$I_{C} = 10mA, I_{B} = 1.0mA$ $I_{C} = 50mA, I_{B} = 5.0mA$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}		6.0	pF	$V_{CB} = 10V, f = 1.0MHz, I_E = 0$
Small Signal Current Gain	h _{FE}	50	250		$V_{CE} = 10V, I_C = 1.0mA, f = 1.0kHz$
Current Gain-Bandwidth Product	f⊤	100	300	MHz	$V_{CE} = 10V, I_C = 10mA, f = 100MHz$
Noise Figure	NF		8.0	dB	$\label{eq:Vce} \begin{array}{l} V_{CE}=5.0V,\ I_{C}=200\mu A,\\ R_{S}=1.0k \ ,\ f=1.0kHz \end{array}$

Ordering Information (Note 6 & 9)

Device	Packaging	Shipping
DMMT5551-7-F	SOT-26	3000/Tape & Reel
DMMT5551S-7-F	SOT-26	3000/Tape & Reel

Notes: 6. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

7. Short duration pulse test used to minimize self-heating effect.

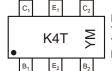
 The DC Current Gain, hFE, (matched at IC = 10mA and VCE = 5V) Collector Emitter Saturation Voltage, VCE(SAT), and Base Emitter Saturation Voltage, VBE(SAT) are matched with typical matched tolerances of 1% and maximum of 2%.

9. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



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ł	ΥM	K4R = DMMT5551 Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September	•	
	В2			6



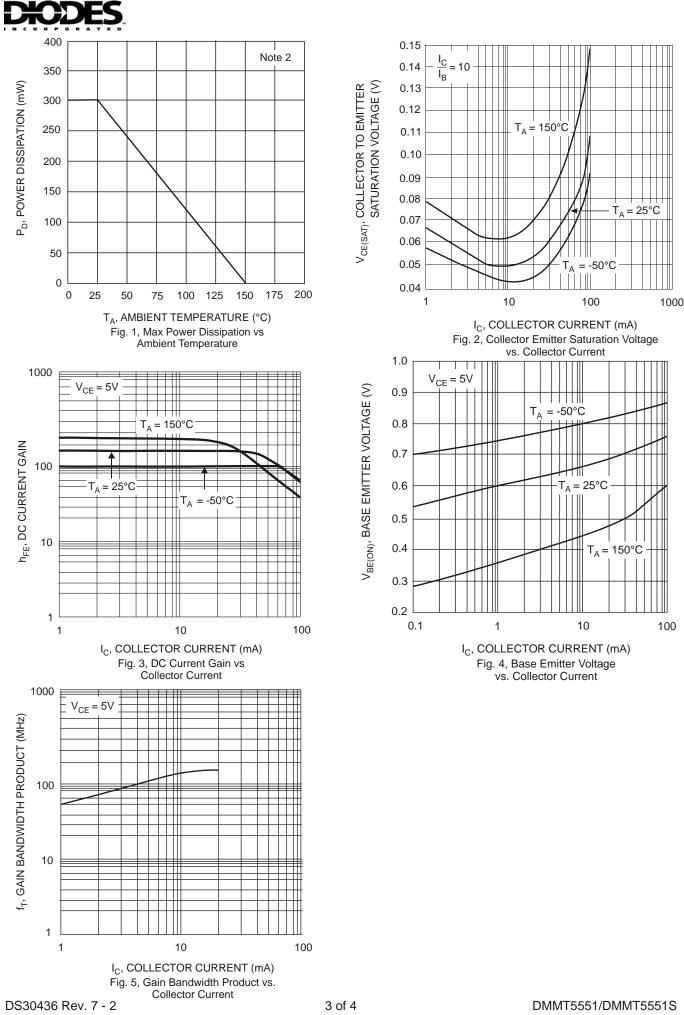
K4T = DMMT5551S Product Type Marking Code YM = Date Code Marking

Y = Year ex: T = 2006M = Month ex: 9 = September

Date Code Key

Year	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	Q	R	S	Т	U	V	W	Х	Y	Z

Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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